

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET



Marking code: P2

PRODUCT SUMMARY					
V _{DS} (V)	30				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.068				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5 \text{ V}$	0.085				
Q _g typ. (nC)	3				
I _D (A) ^a	3.6				
Configuration	Single				

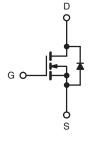
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- DC/DC converter for portable devices
- · Load switch



N-Channel MOSFET

ORDERING INFORMATION				
Package	SOT-23			
Lead (Pb)-free and halogen-free	Si2300DS-T1-GE3			

PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT
		V _{DS}	30	
Gate-source voltage		V _{GS}	± 12	V
	T _C = 25 °C		3.6 ^a	
Continuous drain surrent /T 150 °C)	T _C = 70 °C	1 ,	3	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	3.1 ^{b, c}	
	T _A = 70 °C	1	2.5 ^{b, c}	Α
Pulsed drain current		I _{DM}	15	
Continuous source-drain diode current	T _C = 25 °C		1.4	
	T _A = 25 °C	I _S	0.9 ^{b, c}	
	T _C = 25 °C		1.7	w
Maximum power dissipation	T _C = 70 °C		1.1	
	T _A = 25 °C	P _D	1.1 ^{b, c}	
	T _A = 70 °C	1	0.7 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) d, e			260	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 5 s	R_{thJA}	90	115	°C/W		
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	60	75	C/VV		

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 130 °C/W



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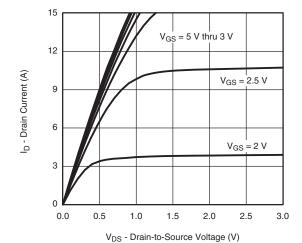
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	21	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-3.2	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6	-	1.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 100	nA	
Zava mata walta na disaisa awasant	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	—— uA	
Zero gate voltage drain current		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10		
On-state drain current a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10	-	-	Α	
Due in account on atota mariatana 3		$V_{GS} = 4.5 \text{ V}, I_D = 2.9 \text{ A}$	-	0.055	0.068	_	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 2.6 \text{ A}$	-	0.070	0.085	Ω	
Forward transconductance a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 2.9 \text{ A}$	-	13	-	S	
Dynamic ^b	. '			•			
Input capacitance	C _{iss}		-	320	-		
Output capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	45	-	pF	
Reverse transfer capacitance	C _{rss}		-	19	-		
Total gate charge	Q _g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.1 \text{ A}$	-	6.5	10		
			-	3	4.5		
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.1 \text{ A}$	-	0.8	-	nC	
Gate-drain charge	Q _{gd}		-	0.5	-		
Gate resistance	R_g	f = 1 MHz	0.6	3.2	6.4	Ω	
Turn-on delay time	t _{d(on)}		-	10	15		
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 6 \Omega$	-	15	25	1	
Turn-off delay time	t _{d(off)}	$I_D\cong 2.5$ A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	20	30		
Fall time	t _f		-	11	20		
Turn-on delay time	t _{d(on)}		-	5	10	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 6 \Omega$	-	12	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 2.5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	15	25		
Fall time	t _f		-	10	15		
Drain-Source Body Diode Characteristic	s			•			
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	1.4	^	
Pulse diode forward current	I _{SM}		-	-	15	A	
Body diode voltage	V _{SD}	$I_S = 2.5 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}		-	11	20	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 2.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	5	10	nC	
Reverse recovery fall time	ta	$T_J = 25 ^{\circ}\text{C}$	-	7	-		
Reverse recovery rise time	t _b		_	4	_	ns	

Notes

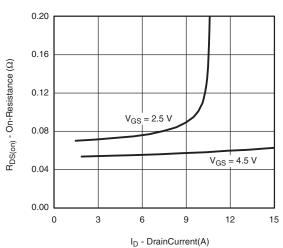
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

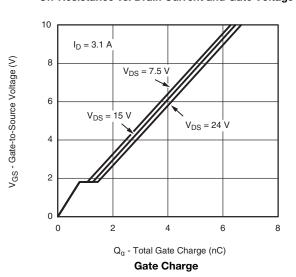


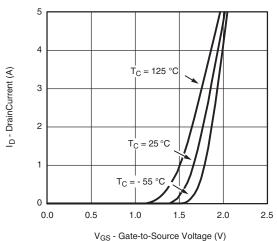


Output Characteristics

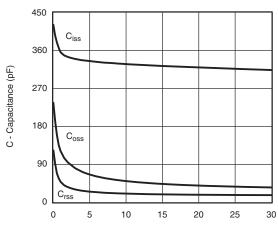


On-Resistance vs. Drain Current and Gate Voltage



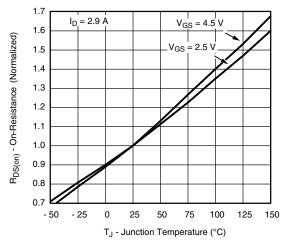


Transfer Characteristics



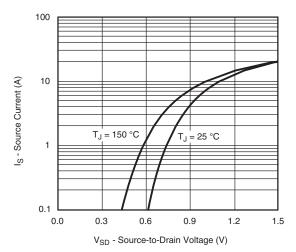
 V_{DS} - Drain-to-SourceVoltage (V)

Capacitance

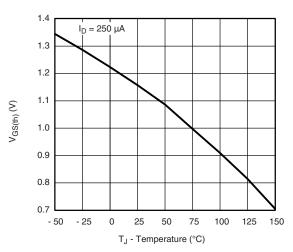


On-Resistance vs. Junction Temperature

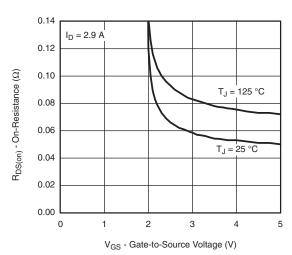




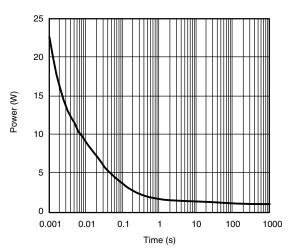
Source-Drain Diode Forward Voltage



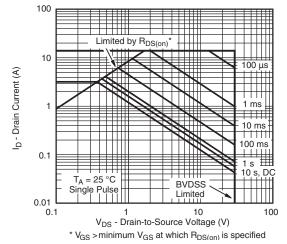
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

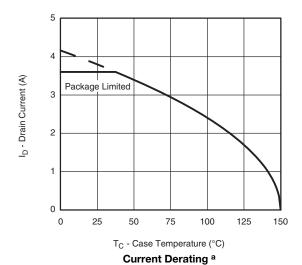


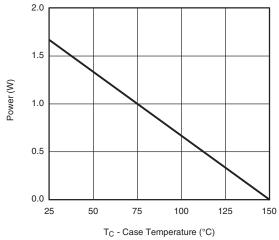
Single Pulse Power



Safe Operating Area, Junction-to-Ambient





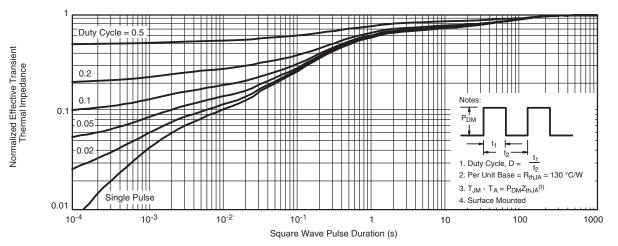


Power Derating

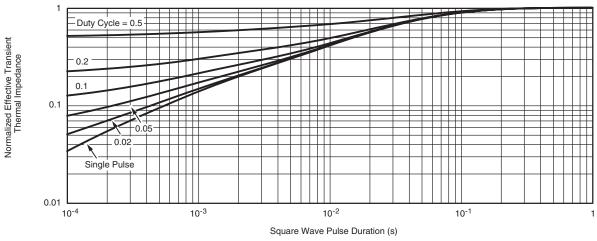
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

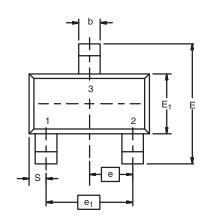


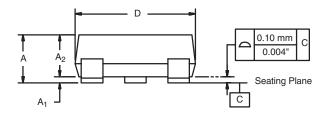
Normalized Thermal Transient Impedance, Junction-to-Foot

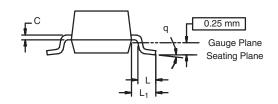
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for silicon technology and package reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65701.

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SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
Е	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01				

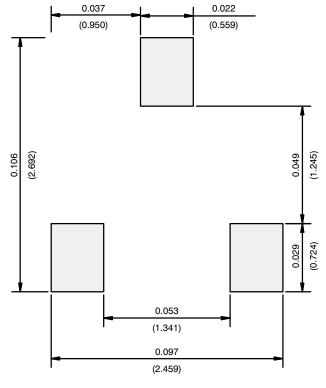
ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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